1. Package summary

Terminal position code D (double)

Package type descriptive code CDFM2

Package type industry code SOT467A

Package style descriptive code CDFM (ceramic double-ended flange mount)

Package style suffix code NA (not applicable)

Package body material typeC (ceramic)Mounting method typeF (flange mount)

Issue date 28-12-1999

Table 1. Package summary

Symbol	Parameter	Min	Тур	Nom	Max	Unit
D	package length	9.04	-	9.145	9.25	mm
E	package width	5.77	-	5.845	5.92	mm
Α	seated height	3.94	-	4.305	4.67	mm
n ₂	actual quantity of termination	-	-	2	-	



NXP Semiconductors SOT467A

flanged ceramic package; 2 mounting holes; 2

2. Package outline

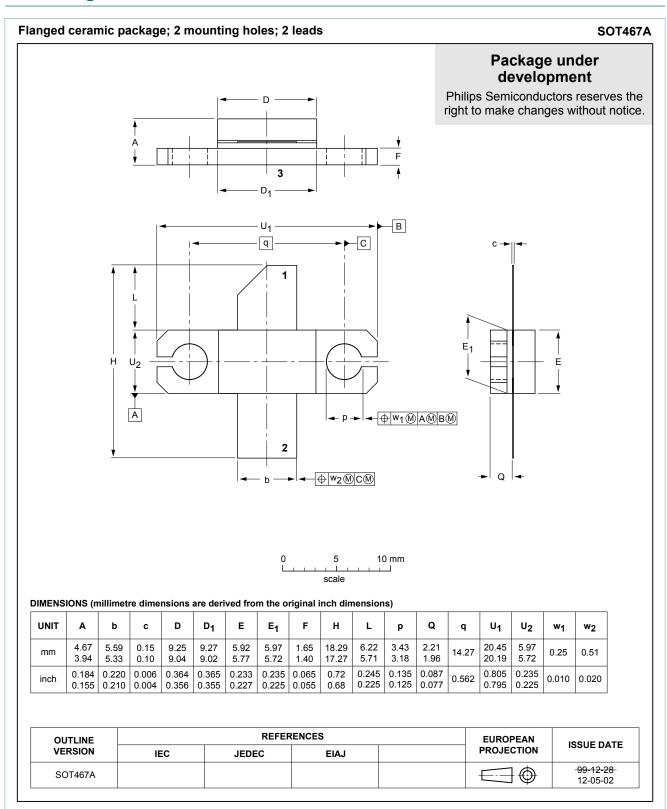


Fig. 1. Package outline SOT467A

NXP Semiconductors SOT467A

flanged ceramic package; 2 mounting holes; 2

3. Legal information

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NXP Semiconductors SOT467A

flanged ceramic package; 2 mounting holes; 2 leads

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